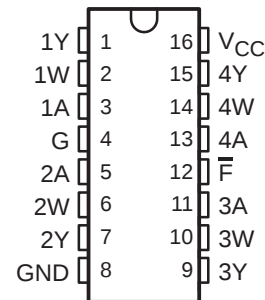


- Meets or Exceeds the Requirements of IBM 360/370 Input/Output Interface Specification GA22-6974-3
- Minimum Output Voltage of 3.11 V at $I_{OH} = -59.3$ mA
- Fault-Flag Circuit Output Signals Driver Output Fault
- Fault-Detection Current-Limit Circuit Minimizes Power Dissipation During a Fault Condition
- Common Enable and Common Fault Flag
- Designed to Be an Improved Replacement for the MC3485

D OR N PACKAGE
(TOP VIEW)



description

The SN75130 quadruple line driver is designed to meet the IBM 360/370 I/O specification GA22-6974-3. The output voltage is 3.11 V minimum (at $I_{OH} = -59.3$ mA) over the recommended ranges of supply voltage (4.5 V to 5.95 V) and temperature (0°C to 70°C). Driver outputs use a fault-detection current-limit circuit to allow high drive current but still minimize power dissipation when the output is shorted to ground. The SN75130 is compatible with standard TTL logic and supply voltages.

Fault-flag circuitry is designed to sense and signal a line short on any Y line. Upon detecting an output fault condition, the fault-flag circuit forces the driver output into the off (low) state and signals a fault condition by causing the fault-flag output to go low.

The SN75130 can drive a 50-Ω load or a 90-Ω load as used in many I/O systems. Optimum performance can be achieved when the device is used with either the SN75128 or SN75129 line receiver. Also, see the SN751730 for new 360/370 interface designs.

The SN75130 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE
(each driver)

INPUTS		OUTPUTS		
$G^\dagger$	A	Y	$\bar{F}$	W
L	X	L	H	H
X	L	L	H	H
H	H	H	H	L
H	H	S	L	H

H = high level, L = low level, X = irrelevant,
S = shorted to ground

† G and $\bar{F}$ are common to the four drivers.
If any of the four Y outputs is shorted, the
fault flag responds.



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**TEXAS
INSTRUMENTS**

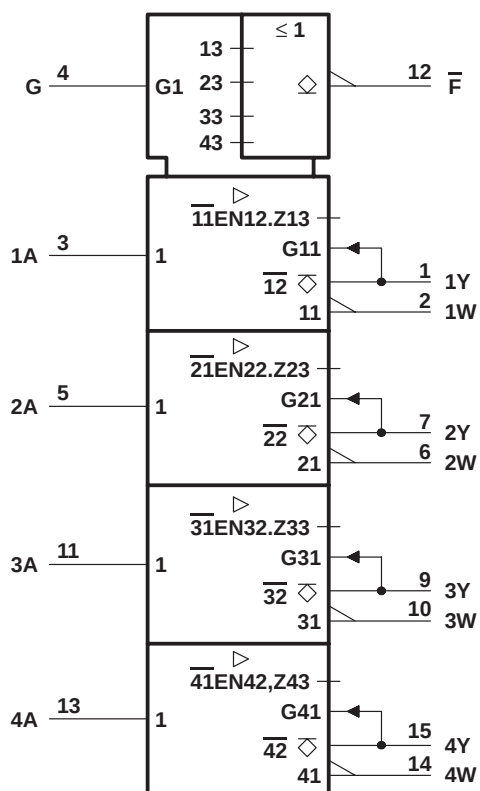
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SN75130 QUADRUPLE LINE DRIVER

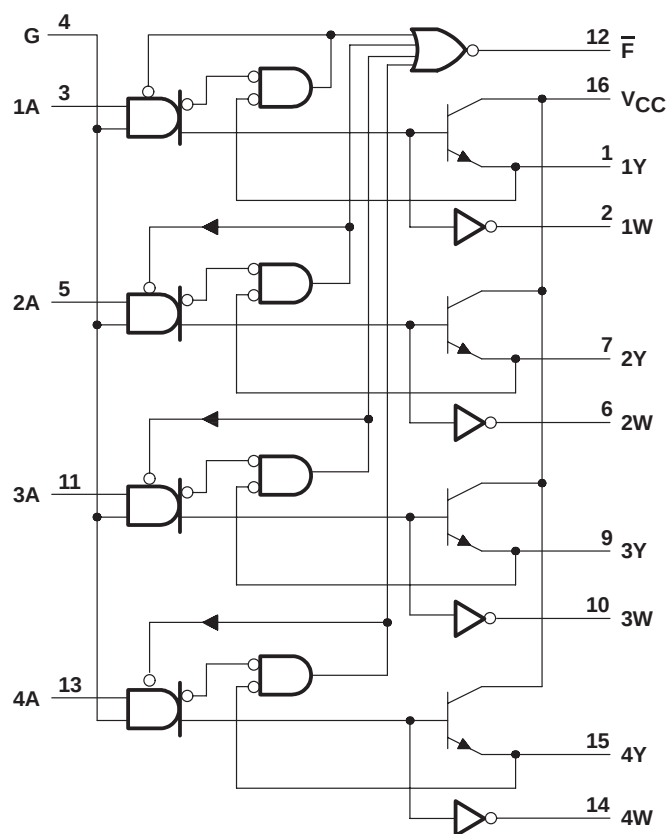
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logic symbol†

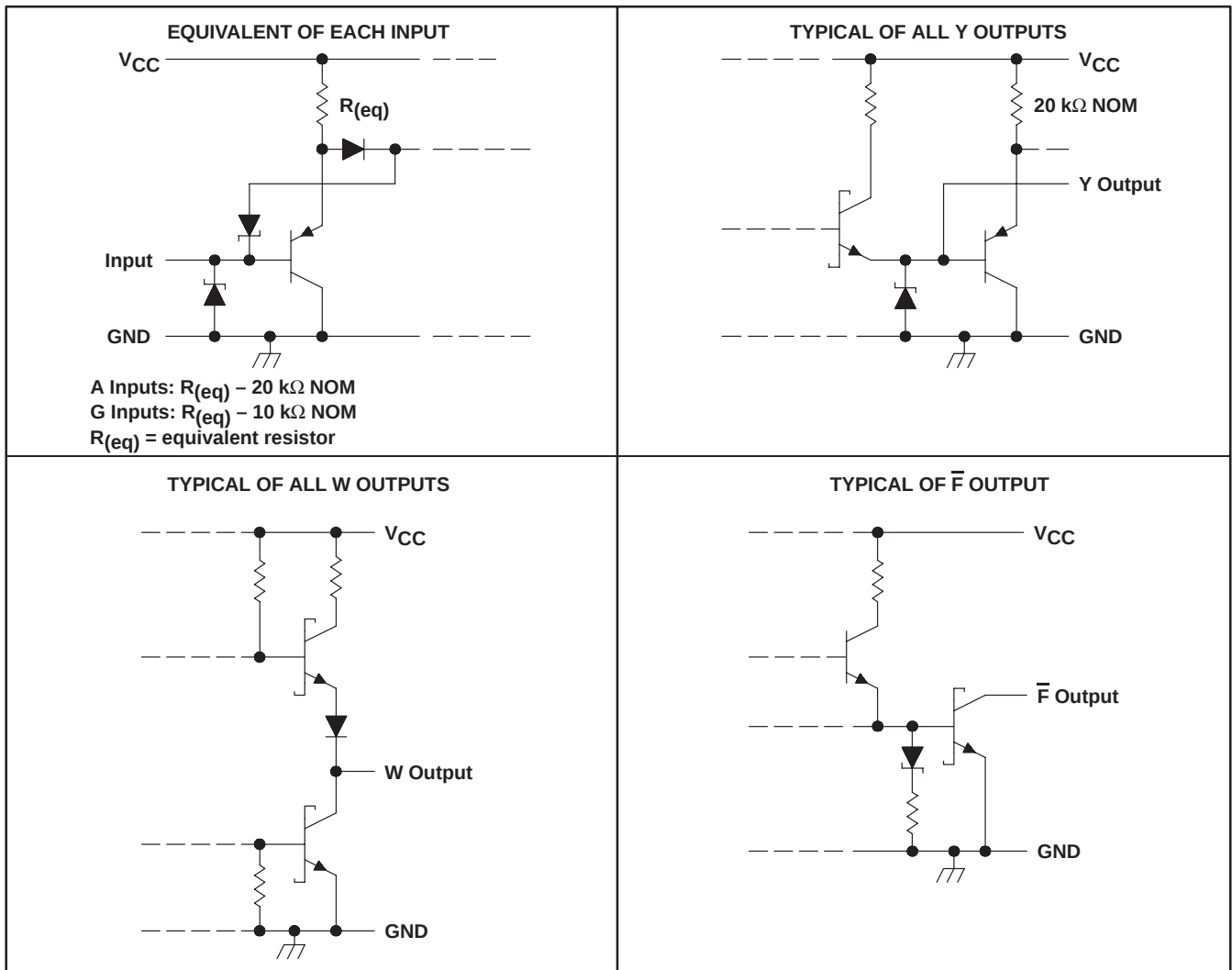


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SN75130

QUADRUPLE LINE DRIVER

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DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	OPERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING
D	950 mW	7.6 mW/ $^\circ\text{C}$	608 mW
N	1150 mW	9.2 mW/ $^\circ\text{C}$	736 mW

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.5	5	5.95	V
High-level input voltage, V_{IH}	2			V
Low-level input voltage, V_{IL}			0.8	V
High-level output current, I_{OH}			-59.3	mA
Operating free-air temperature, T_A	0		70	$^\circ\text{C}$

electrical characteristics over recommended operating free-air temperature range

PARAMETER			TEST CONDITIONS			MIN	MAX	UNIT
V_{IK}	Input clamp voltage	A, G	$I_I = -18\text{ mA}$				-1.5	V
V_{OH}	High-level output voltage	Y	$V_{CC} = 4.5\text{ V}$, $I_{OH} = -59.3\text{ mA}$, $V_{IH} = 2\text{ V}$			3.11		V
		Y	$V_{CC} = 5.25\text{ V}$, $I_{OH} = -41\text{ mA}$, $V_{IH} = 2\text{ V}$			3.9		
		W	$V_{CC} = 4.5\text{ V}$, $I_{OH} = -400\text{ }\mu\text{A}$, $V_{IH} = 2\text{ V}$			2.5		
V_{OL}	Low-level output voltage	Y	$V_{CC} = 5.5\text{ V}$, $I_{OL} = -240\text{ }\mu\text{A}$, $V_{IL} = 0.8\text{ V}$				0.15	V
		Y	$V_{CC} = 5.95\text{ V}$, $I_{OL} = -1\text{ mA}$, $V_{IL} = 0.8\text{ V}$				0.15	
		$\bar{F}$	$V_{CC} = 4.5\text{ V}$, $I_{OL} = 8\text{ mA}$, Y at 0 V				0.5	
		W	$V_{CC} = 4.5\text{ V}$, $I_{OL} = 8\text{ mA}$				0.5	
$I_{O(off)}$	Off-state output current	Y	$V_{CC} = 4.5\text{ V}$, $V_{IL} = 0$, $V_O = 3.11\text{ V}$				100	μA
		Y	$V_{CC} = 0$, $V_{IL} = 0$, $V_O = 3.11\text{ V}$				200	
I_{OH}	High-level output current	$\bar{F}$	$V_{CC} = 5.95\text{ V}$, $V_{OH} = 5.95\text{ V}$				100	μA
I_I	Input current	A	$V_{CC} = 4.5\text{ V}$, $V_{IH} = 5.5\text{ V}$				100	μA
		G					400	
I_{IH}	High-level input current	A	$V_{CC} = 4.5\text{ V}$, $V_{IH} = 2.7\text{ V}$				20	μA
		G					80	
I_{IL}	Low-level input current	A	$V_{CC} = 5.95\text{ V}$, $V_{IL} = 0.4\text{ V}$				250	μA
		G					-1000	
I_{OS}	Short-circuit output current	Y	$V_{CC} = 5.5\text{ V}$, $V_O = 0$				-5	mA
		W				-15	-100	
		Y	$V_{CC} = 5.95\text{ V}$, $V_O = 0$				-5	
		W				-15	-110	
I_{CCH}	Supply current, all outputs high		$V_{CC} = 5.5\text{ V}$, $V_I = 2\text{ V}$				75	mA
			$V_{CC} = 5.95\text{ V}$, $V_I = 2\text{ V}$				85	
I_{CCL}	Supply current, Y outputs low		$V_{CC} = 5.5\text{ V}$, $V_I = 0.8\text{ V}$				55	mA
			$V_{CC} = 5.95\text{ V}$, $V_I = 0.8\text{ V}$				70	

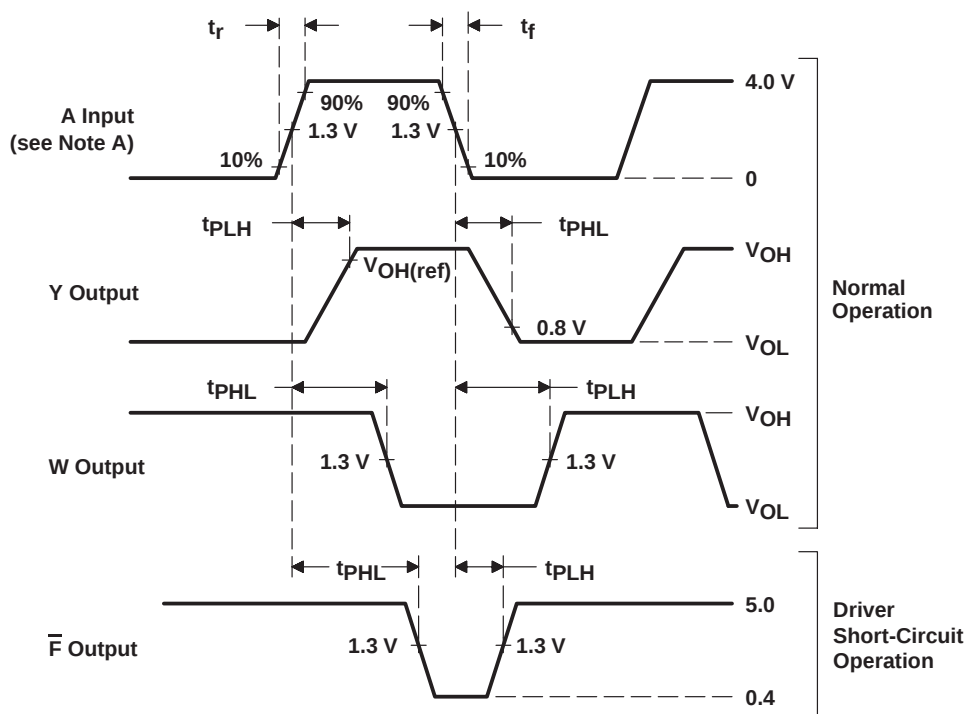
switching characteristics over recommended operating free-air temperature range

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	A	Y	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ Input $f = 1 \text{ MHz},$ $V_{OH(ref)} = 3.11 \text{ V},$ $R_L = 50 \Omega,$ See Figures 1 and 2		40	ns
t_{PHL}	Propagation delay time, high- to low-level output					37	ns
$\frac{t_{PLH}}{t_{PHL}}$	Ratio of propagation delay times				0.3	3	
t_{PLH}	Propagation delay time, low- to high-level output	A	Y	$V_{CC} = 5.25 \text{ V to } 5.59 \text{ V},$ $C_L = 50 \text{ pF},$ Input $f = 5 \text{ MHz},$ $V_{OH(ref)} = 3.9 \text{ V},$ $R_L = 90 \Omega,$ See Figures 1 and 2		45	ns
t_{PHL}	Propagation delay time, high- to low-level output					45	ns
t_{PLH}	Propagation delay time, low- to high-level output	A	W	$V_{CC} = 5 \text{ V},$ $C_L = 15 \text{ pF},$ $R_L = 2 \text{ k}\Omega,$ See Figures 1 and 2		45	ns
t_{PHL}	Propagation delay time, high- to low-level output					28	ns
t_{PLH}	Propagation delay time, low- to high-level output	A	$\bar{F}$	$V_{CC} = 5 \text{ V},$ $C_L = 15 \text{ pF},$ $R_L = 2 \text{ k}\Omega,$ See Figures 1 and 2		60	ns
t_{PHL}	Propagation delay time, high- to low-level output					100	ns

SN75130 QUADRUPLE LINE DRIVER

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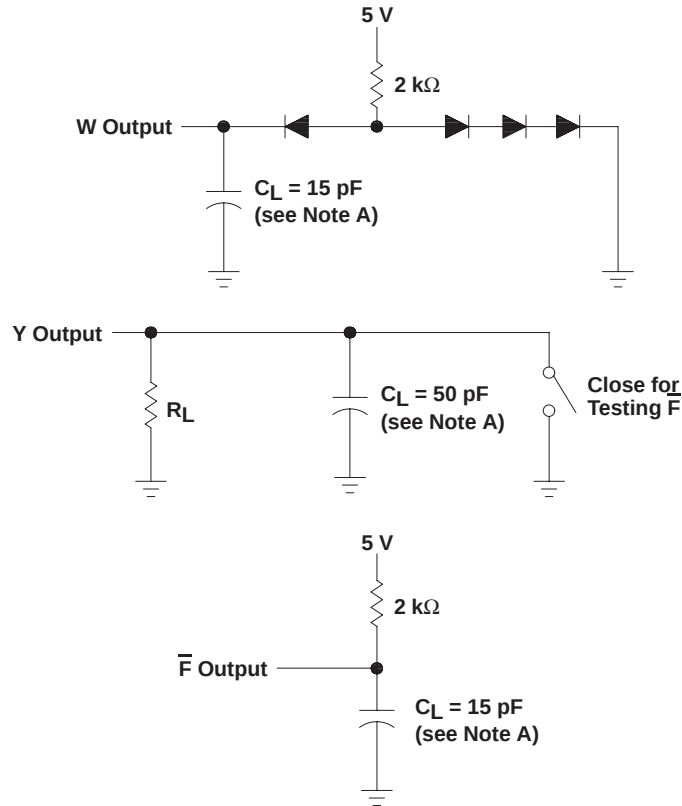
PARAMETER MEASUREMENT INFORMATION



NOTE A: The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_O = 50 \Omega$.

Figure 1. Input and Output Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTE A: C_L includes probe and stray capacitance.

Figure 2. Switching Characteristics Load Circuits

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75130D	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN75130N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

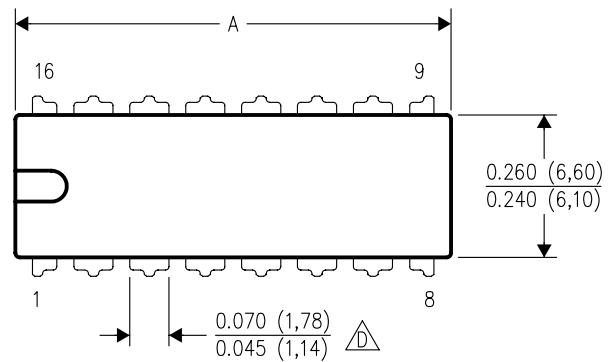
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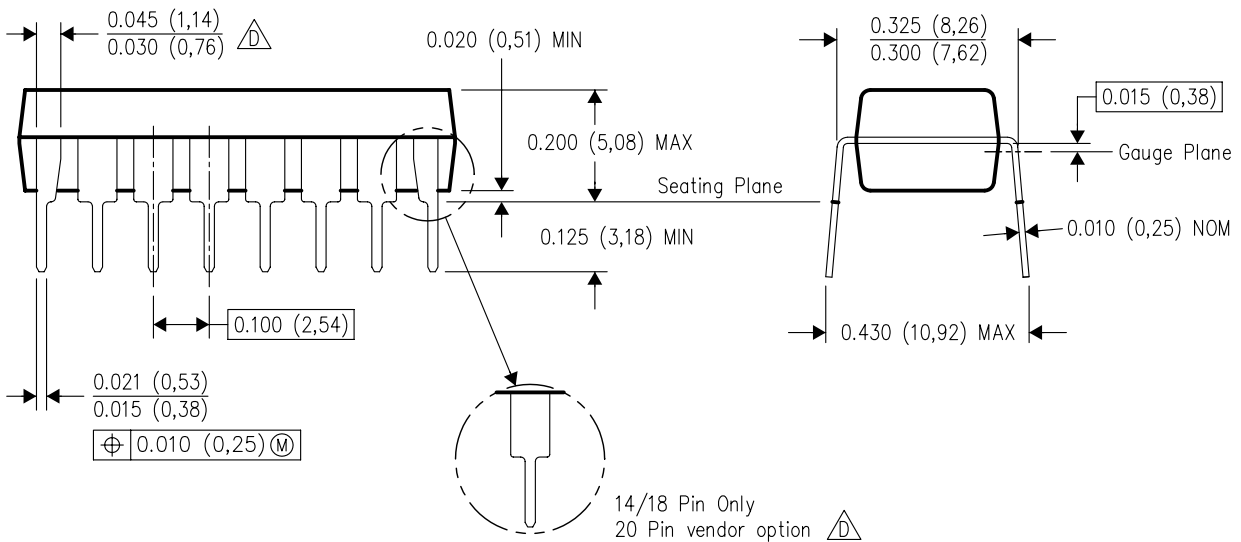
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



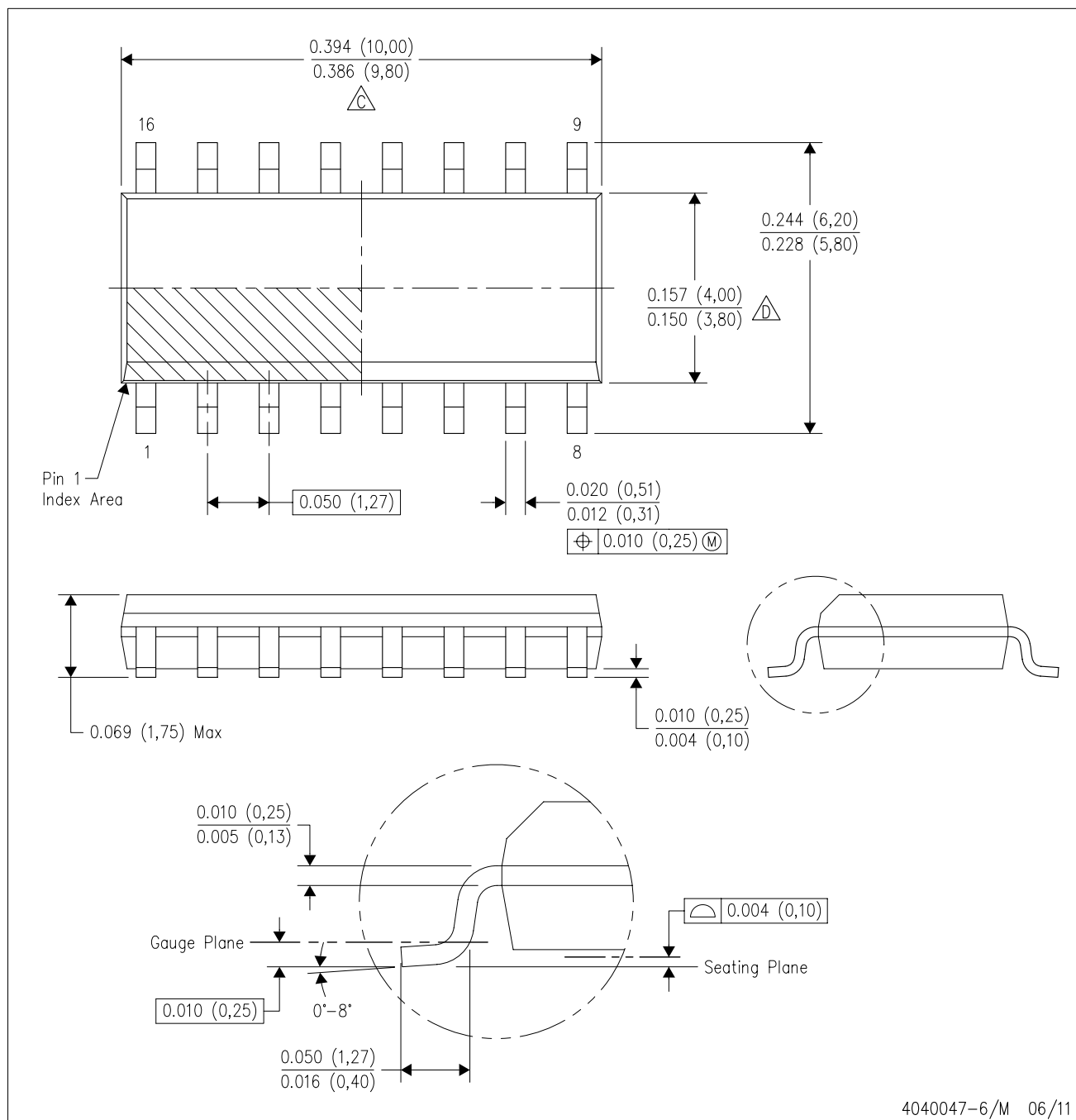
14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

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